

# 2KBP005M/3N253 - 2KBP10M/3N259

## Features

- Surge overload rating: 60 amperes peak.
- Reliable low cost construction utilizing molded plastic technique.
- UL certified, UL #E111753.



## 2.0 Ampere Bridge Rectifiers

### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value	Units
$I_{F(AV)}$	Average Rectified Current	2.0	A
$I_{FSM}$	Non-repetitive Peak Forward Surge Current	60	A
$P_D$	Total Device Dissipation	4.7	W
	Derate above $25^\circ\text{C}$	33	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,** per leg	30	$^\circ\text{C/W}$
$T_{stg}$	Storage Temperature Range	-55 to +165	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-55 to +165	$^\circ\text{C}$

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

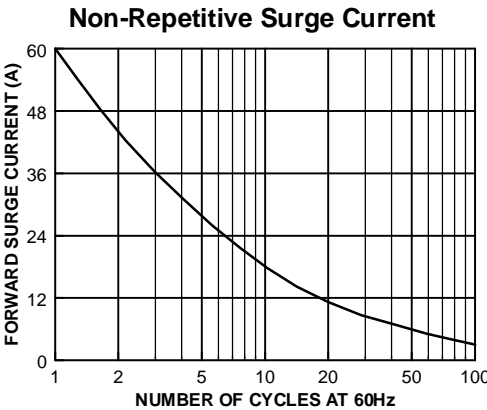
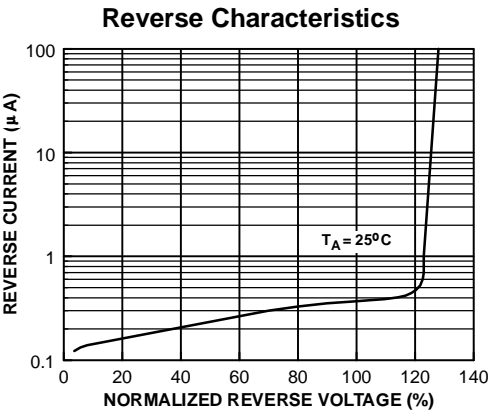
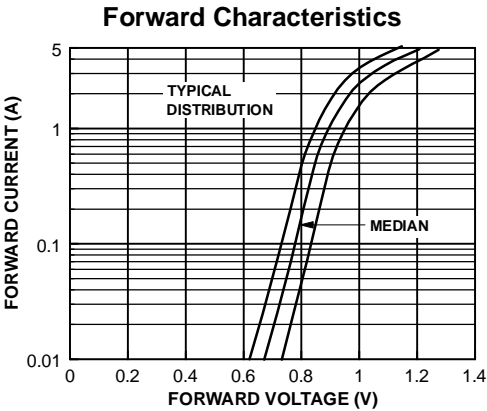
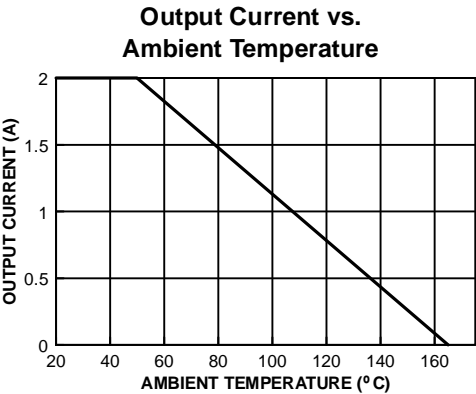
\*\* Device mounted on PCB with 0.47 x 0.47" (12 x 12 mm).

### Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Device								Units
		005M	01M	02M	04M	06M	08M	10M		
		253	254	255	256	257	258	259		
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V	
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V	
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V	
I <sub>RM</sub>	Maximum Instantaneous Reverse Leakage, total bridge @ rated V <sub>R</sub> T <sub>A</sub> = 25°C T <sub>A</sub> = 125°C	5.0 500							μA μA	
V <sub>FM</sub>	Maximum Instantaneous Forward Voltage Drop, per bridge @ 3.14 A	1.1							V	
	I <sup>2</sup> t rating for fusing t < 8.35 ms	15							A <sup>2</sup> s	
C	Typical Junction Capacitance, per leg V <sub>R</sub> = 4.0 V. f = 1.0 MHz	25							pF	

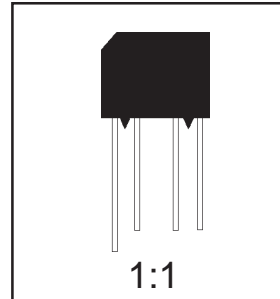
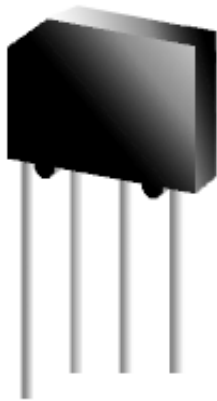
Typical Characteristics



## KBPM Package Dimensions



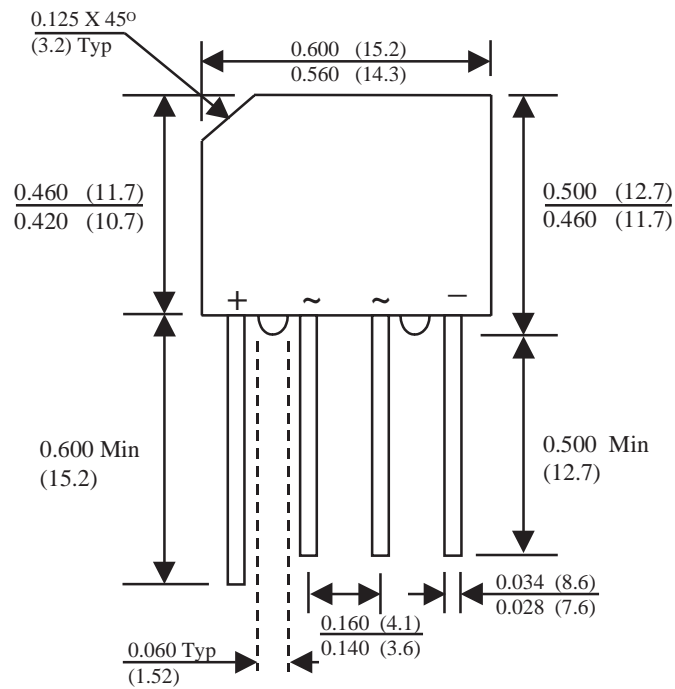
### KBPM (FS PKG Code R1)



Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 1.7



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